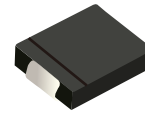
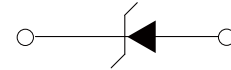


## FEATURES

- | Low profile package
- | Ideal for automated placement
- | 1500 Watt peak pulse power capability with a 10/1000 $\mu$ s waveform
- | For surface mounted applicatons to optimize board space
- | Excellent clamping capability
- | Very fast response time
- | Low incremental surge resistance
- | Meet AEC-Q101 Requirements



DO-214AB(SMC)



Schematic Symbol

## APPLICATIONS

- | Power supply protection
- | Automotive application
- | Industrial application
- | Power management

## APPROVALS

|      |                                    |
|------|------------------------------------|
| RoHS | Compliance with 2011/65/EU         |
| HF   | Compliance with IEC61249-2-21:2003 |

## MAXIMUM RATINGS ( $T_A=25^{\circ}\text{C}$ )

| Parameter                                                                                       | Symbol    | Value | Unit  |
|-------------------------------------------------------------------------------------------------|-----------|-------|-------|
| Peak Pulse Power Dissipation on 10/1000 $\mu$ s waveform (Note1, Note2).                        | $P_{PPM}$ | 1500  | Watts |
| Steady State Power Dissipation at $T_L=50^{\circ}\text{C}$ , Lead lengths.375" (9.5mm) ( Note2) | $P_D$     | 6.5   | Watts |

**Notes :** 1.Non-repetitive current pulse,  $T_A=25^{\circ}\text{C}$ .  
 2.Mounted on 5.0mm\*5.0mm (0.03mm thick) Copper Pads to each terminal.

## THERMAL CONSIDERATIONS

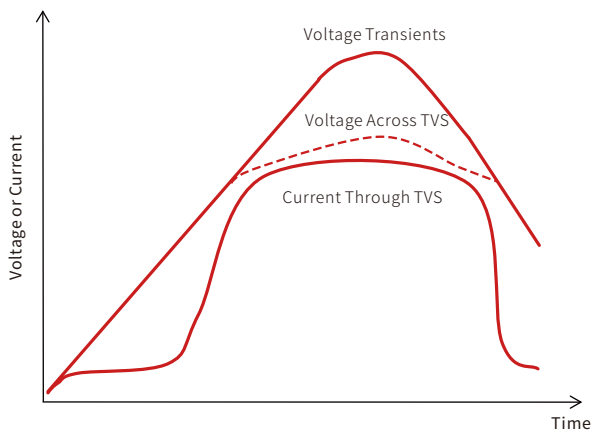
| Parameter                              | Symbol          | Value       | Unit                 |
|----------------------------------------|-----------------|-------------|----------------------|
| Operating Junction Temperature         | $T_J$           | -55 to +150 | $^{\circ}\text{C}$   |
| Storage Temperature Range              | $T_{STG}$       | -55 to +150 | $^{\circ}\text{C}$   |
| Junction to Ambient on printed circuit | $R_{\theta JA}$ | 75          | $^{\circ}\text{C/W}$ |

## ELECTRICAL CHARACTERISTICS ( $T_A=25^\circ\text{C}$ )

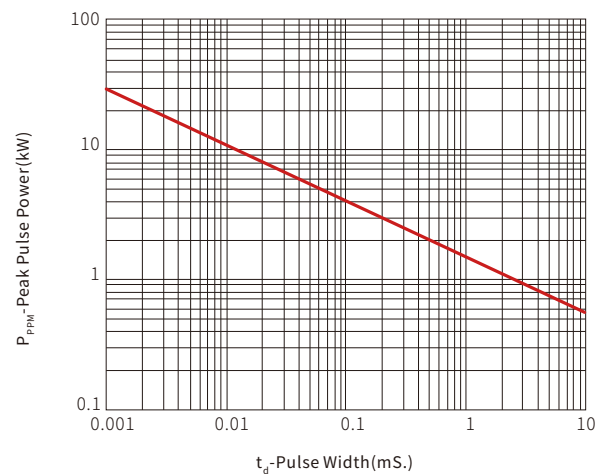
| Part Number | Device Marking Code | Reverse Stand-off Voltage | Breakdown Voltage Min.@ $I_T$ | Breakdown Voltage Max.@ $I_T$ | Test Current | Maximum Clamping Voltage @ $I_{PP}$ | Peak Pulse Current | Reverse Leakage @ $V_{RWM}$ |
|-------------|---------------------|---------------------------|-------------------------------|-------------------------------|--------------|-------------------------------------|--------------------|-----------------------------|
|             |                     | $V_{RWM}$ (V)             | $V_{BR}$ (V)                  | $V_{BR}$ (V)                  | $I_T$ (mA)   | $V_C$ (V)                           | $I_{PP}$ (A)       | $I_R$ ( $\mu\text{A}$ )     |
| TPSVC150U60 | GGKA                | 60.0                      | 66.7                          | 73.7                          | 1.0          | 96.8                                | 15.5               | 1.0                         |

## CHARACTERISTIC CURVES

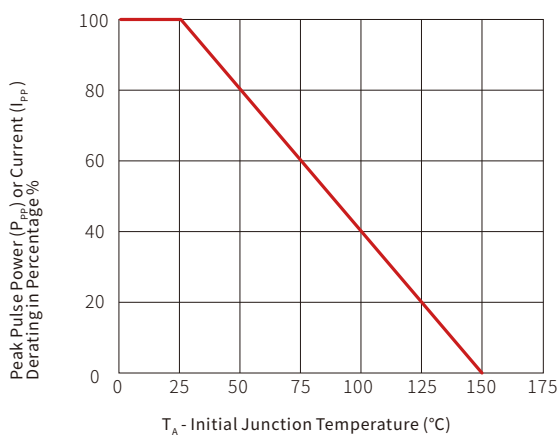
TVS Transients Clamping Waveform



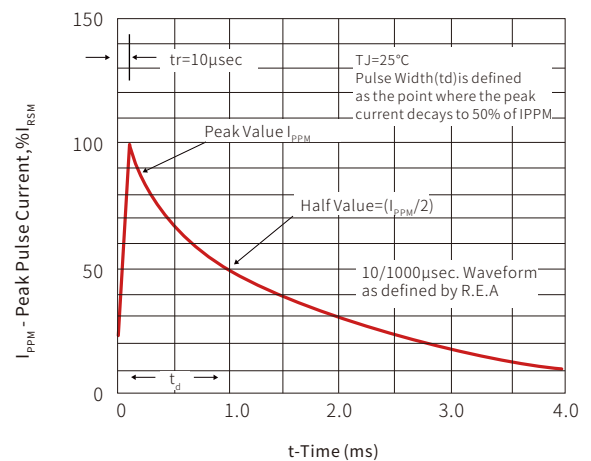
Peak Pulse Power Rating Curve



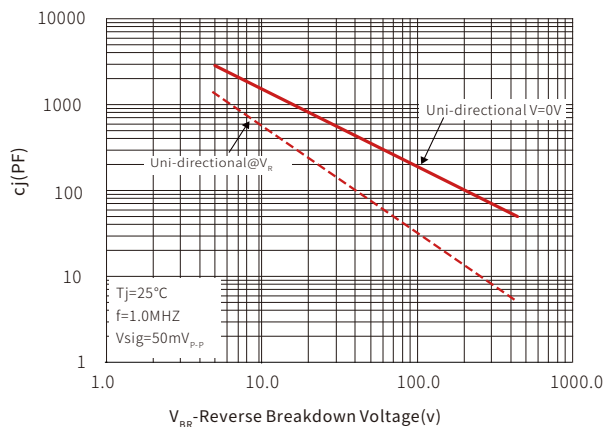
Pulse Derating Curve



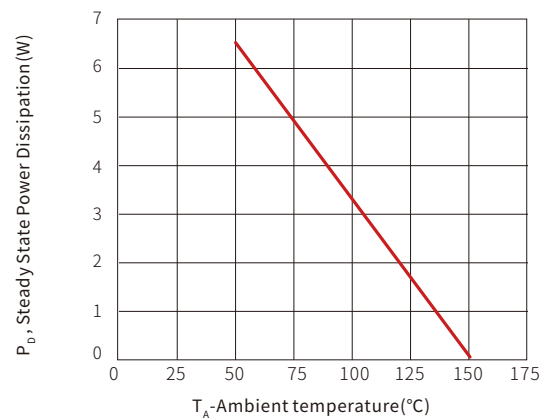
Pulse Waveform



Typical Junction Capacitance

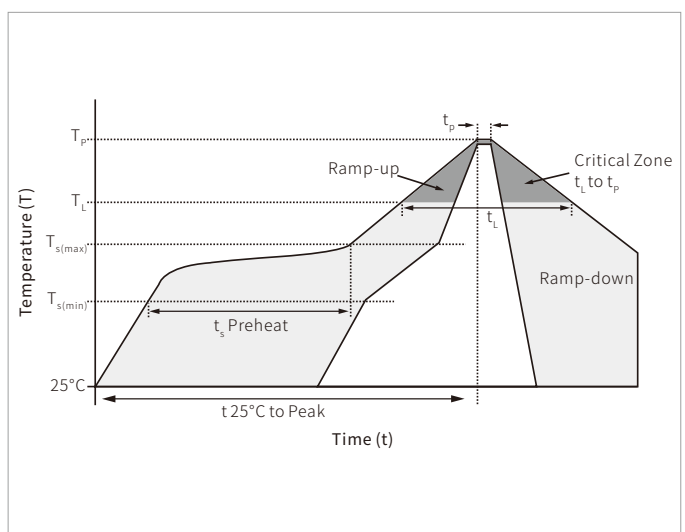


Steady State Power Dissipation Derating Curve

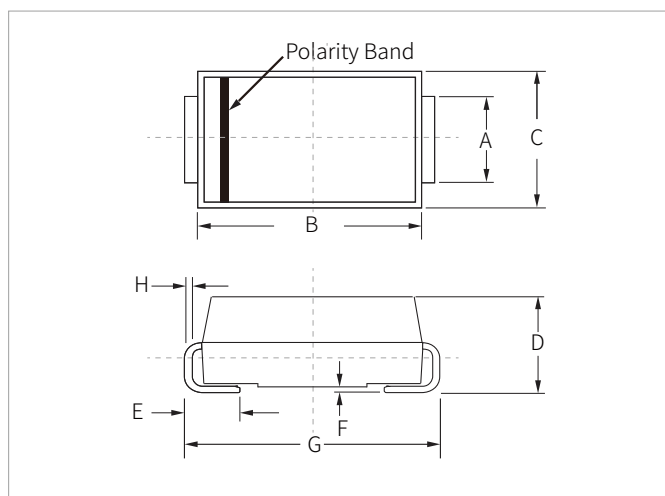


## SOLDERING PARAMETERS

| Reflow Condition                                       |                                  | Lead-free assembly |
|--------------------------------------------------------|----------------------------------|--------------------|
| Pre Heat                                               | Temperature Max ( $T_{s(min)}$ ) | 150°C              |
|                                                        | Temperature Max ( $T_{s(max)}$ ) | 200°C              |
|                                                        | Time (min to max) ( $t_s$ )      | 60 – 180 secs      |
| Average ramp up rate (Liquidus Temp ( $T_L$ ) to peak) |                                  | 3°C/second max     |
| $T_{s(max)}$ to $T_L$ - Ramp-up Rate                   |                                  | 3°C/second max     |
| Reflow                                                 | Temperature ( $T_L$ ) (Liquidus) | 217°C              |
|                                                        | Time (min to max) ( $t_L$ )      | 60 – 150 seconds   |
| Peak Temperature ( $T_p$ )                             |                                  | 260°C              |
| Time within 5°C of actual peak Temperature ( $t_p$ )   |                                  | 20 – 40 seconds    |
| Ramp-down Rate                                         |                                  | 6°C/second max     |
| Time 25°C to peak Temperature ( $T_p$ )                |                                  | 8 minutes max.     |
| Do not exceed                                          |                                  | 260°C              |

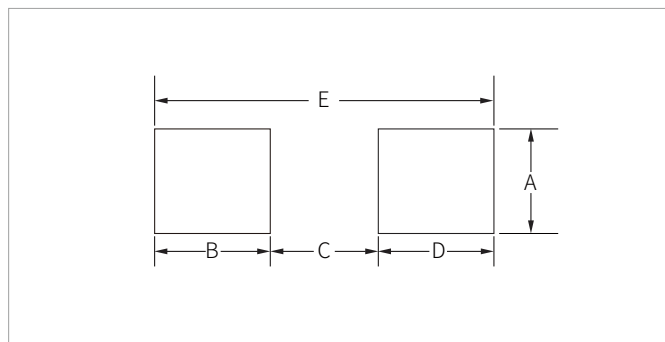


## DO-214AB(SMC) PACKAGE INFORMATION



| Ref. | Millimeters |      | Inches |       |
|------|-------------|------|--------|-------|
|      | Min.        | Max. | Min.   | Max.  |
| A    | 2.80        | 3.20 | 0.110  | 0.126 |
| B    | 6.60        | 7.20 | 0.260  | 0.283 |
| C    | 5.70        | 6.10 | 0.224  | 0.240 |
| D    | 2.15        | 2.75 | 0.085  | 0.108 |
| E    | 1.00        | 1.60 | 0.039  | 0.063 |
| F    | 0.02        | 0.20 | 0.000  | 0.008 |
| G    | 7.60        | 8.00 | 0.299  | 0.315 |
| H    | 0.15        | 0.30 | 0.006  | 0.012 |

## RECOMMENDED PAD LAYOUT DIMENSIONS



| Ref. | Millimeters |      | Inches   |       |
|------|-------------|------|----------|-------|
|      | Min.        | Max. | Min.     | Max.  |
| A    | 3.30        | -    | 0.129    | -     |
| B    | 2.40        | -    | 0.094    | -     |
| C    | -           | 4.20 | -        | 0.165 |
| D    | 2.40        | -    | 0.094    | -     |
| E    | 8.20REF     |      | 0.323REF |       |

## ORDERING INFORMATION

| Part Number | Component Package | QTY/Reel | Reel Size |
|-------------|-------------------|----------|-----------|
| TPSVC150U60 | DO-214AB(SMC)     | 3000PCS  | 13"       |

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